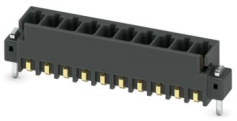
# MCV 0,5/10-G-2,54 SMD R56 - PCB header

1821627

https://www.phoenixcontact.com/us/products/1821627

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PCB headers, nominal cross section: 0.5 mm$^2$, color: black, nominal current: 6 A, rated voltage (III/2): 160 V, contact surface: Au, contact connection type: Pin, number of potentials: 10, number of rows: 1, number of positions: 10, number of connections: 10, product range: MCV 0,5/..-G-SMD, pitch: 2.54 mm, mounting: SMD soldering, pin layout: Linear pad geometry, number of solder pins per potential: 1, plug-in system: COMBICON FMC 0,5, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: 56 mm wide tape

## Your advantages

- Designed for integration into the SMT soldering process
- Additional solder anchors reduce the mechanical strain on the soldering spots
- Gold-plated contacts ensure transfer quality remains stable over the long term
- Vertical connection enables multi-row arrangement on the PCB
- Supplied in tape-on-reel packing according to IEC 60286-3 for automated mounting

## Commercial data

| | |
|---|---|
| Item number | 1821627 |
| Packing unit | 315 pc |
| Minimum order quantity | 315 pc |
| Note | Made to order (non-returnable) |
| Sales key | AA01 |
| Product key | AAAUAB |
| GTIN | 4046356789783 |
| Weight per piece (including packing) | 3.18 g |
| Weight per piece (excluding packing) | 3.18 g |
| Customs tariff number | 85366930 |
| Country of origin | PL |

# Technical data

## Product properties

| | |
|---|---|
| Product type | PCB headers |
| Product family | MCV 0,5/..-G-SMD |
| Product line | COMBICON Connectors XS |
| Number of positions | 10 |
| Pitch | 2.54 mm |
| Number of connections | 10 |
| Number of rows | 1 |
| Number of potentials | 10 |
| Mounting type | without |
| Pin layout | Linear pad geometry |
| Solder pins per potential | 1 |

### Fitting of components

| | |
|---|---|
| Partial assembly | No |

## Electrical properties

### Properties

| | |
|---|---|
| Nominal current $I_N$ | 6 A |
| Nominal voltage $U_N$ | 160 V |
| Contact resistance | 2.6 mΩ |
| Rated voltage (III/3) | 32 V |
| Rated surge voltage (III/3) | 2.5 kV |
| Rated voltage (III/2) | 160 V |
| Rated surge voltage (III/2) | 2.5 kV |
| Rated voltage (II/2) | 160 V |
| Rated surge voltage (II/2) | 2.5 kV |

## Mounting

| | |
|---|---|
| Mounting type | SMD soldering |
| Pin layout | Linear pad geometry |

### Processing notes

| | |
|---|---|
| Process | Reflow soldering |
| Moisture Sensitive Level | MSL 1 |
| Classification temperature $T_c$ | 260 °C |
| Solder cycles in the reflow | 3 |

## Material specifications

### Material data - contact

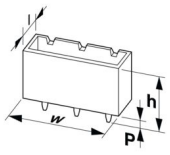
| | |
|---|---|
| Note | WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201 |

| | |
|---|---|
| Contact material | Cu alloy |
| Surface characteristics | Completely gold-plated |
| Metal surface contact area (top layer) | Gold (min. 0.25 µm Au) |
| Metal surface contact area (middle layer) | Nickel (2 µm - 4 µm Ni) |
| Metal surface soldering area (top layer) | Gold (0.25 µm Au) |
| Metal surface soldering area (middle layer) | Nickel (2 µm - 4 µm Ni) |

Material data - housing

| | |
|---|---|
| Color (Housing) | black (9005) |
| Insulating material | LCP |
| Insulating material group | IIIa |
| CTI according to IEC 60112 | 175 |
| Flammability rating according to UL 94 | V0 |

## Dimensions

| | |
|---|---|
| Dimensional drawing |  |
| Pitch | 2.54 mm |
| Width [w] | 29.98 mm |
| Height [h] | 7.1 mm |
| Length [l] | 4.85 mm |
| Pin dimensions | 0.64 x 0.64 mm |

PCB design

| | |
|---|---|
| Pad geometry | 1.2 x 2.85 mm |

## Mechanical tests

Visual inspection

| | |
|---|---|
| Specification | IEC 60512-1-1:2002-02 |
| Result | Test passed |

Dimension check

| | |
|---|---|
| Specification | IEC 60512-1-2:2002-02 |
| Result | Test passed |

Resistance of inscriptions

| | |
|---|---|
| Specification | IEC 60068-2-70:1995-12 |
| Result | Test passed |

Polarization and coding

| | |
|---|---|
| Specification | IEC 60512-13-5:2006-02 |
| Result | Test passed |

Contact holder in insert

| | |
|---|---|
| Specification | IEC 60512-15-1:2008-05 |
| Contact holder in insert<br>Requirements >20 N | Test passed |

Insertion and withdrawal forces

| | |
|---|---|
| Specification | IEC 60512-13-2:2006-02 |
| Result | Test passed |
| No. of cycles | 100 |
| Insertion strength per pos. approx. | 2 N |
| Withdraw strength per pos. approx. | 2 N |

## Electrical tests

Thermal test | Test group C

| | |
|---|---|
| Specification | IEC 60512-5-1:2002-02 |
| Tested number of positions | 16 |

Insulation resistance

| | |
|---|---|
| Specification | IEC 60512-3-1:2002-02 |
| Insulation resistance, neighboring positions | > 5 MΩ |

Air clearances and creepage distances |

| | |
|---|---|
| Specification | IEC 60664-1:2007-04 |
| Insulating material group | IIIa |
| Comparative tracking index (IEC 60112) | CTI 175 |
| Rated insulation voltage (III/3) | 32 V |
| Rated surge voltage (III/3) | 2.5 kV |
| minimum clearance value - non-homogenous field (III/3) | 1.5 mm |
| minimum creepage distance (III/3) | 1.5 mm |
| Rated insulation voltage (III/2) | 160 V |
| Rated surge voltage (III/2) | 2.5 kV |
| minimum clearance value - non-homogenous field (III/2) | 1.5 mm |
| minimum creepage distance (III/2) | 1.6 mm |
| Rated insulation voltage (II/2) | 160 V |
| Rated surge voltage (II/2) | 2.5 kV |
| minimum clearance value - non-homogenous field (II/2) | 1.5 mm |
| minimum creepage distance (II/2) | 1.6 mm |

## Environmental and real-life conditions

Durability test

| | |
|---|---|
| Specification | IEC 60512-9-1:2010-03 |
| Impulse withstand voltage at sea level | 2.95 kV |
| Contact resistance $R_1$ | 2.6 mΩ |
| Contact resistance $R_2$ | 2.6 mΩ |

| | |
|---|---|
| Insertion/withdrawal cycles | 100 |
| Insulation resistance, neighboring positions | > 5 MΩ |

Climatic test

| | |
|---|---|
| Specification | DIN 50018:2013-05 |
| Corrosive stress | 1.0 $dm^3$ $SO_2$ on 300 $dm^3$/40 °C/3 cycles |
| Thermal stress | 100 °C/168 h |
| Power-frequency withstand voltage | 1.39 kV |

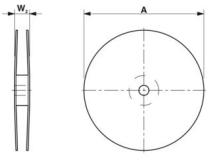
Vibration test

| | |
|---|---|
| Specification | IEC 60068-2-6:2007-12 |
| Frequency | 10 - 500 - 10 Hz |
| Sweep speed | 1 octave/min |
| Amplitude | 0.35 mm (10 Hz ... 60.1 Hz) |
| Acceleration | 5g (60.1 Hz ... 500 Hz) |
| Test duration per axis | 2 h |
| Test directions | X-, Y- and Z-axis (pos. and neg.) |

Ambient conditions

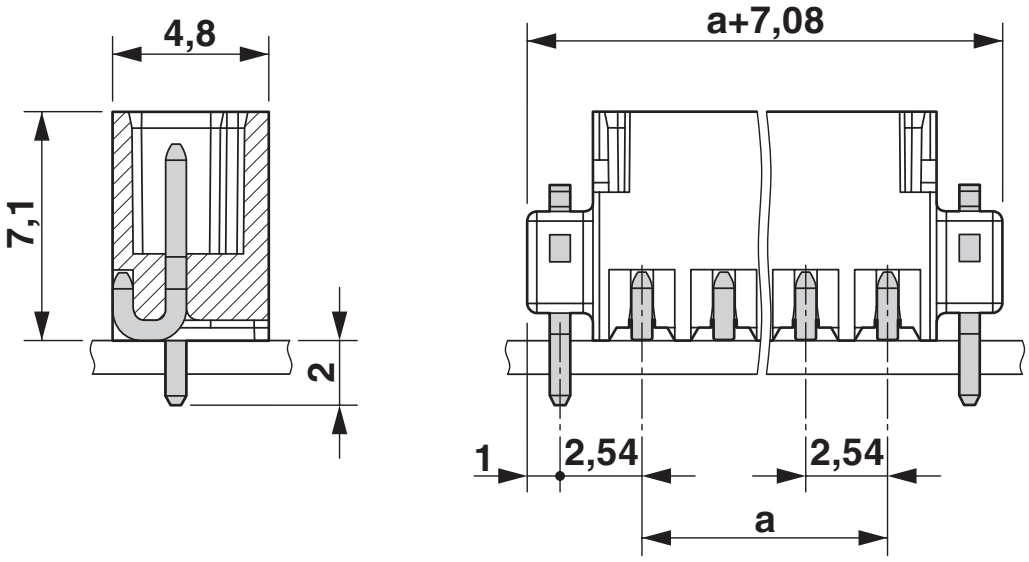
| | |
|---|---|
| Ambient temperature (storage/transport) | -40 °C ... 70 °C |
| Relative humidity (storage/transport) | 30 % ... 70 % |
| Ambient temperature (assembly) | -5 °C ... 100 °C |
| Ambient temperature (operation) | -40 °C ... 100 °C (dependent on the derating curve) |

## Packaging specifications

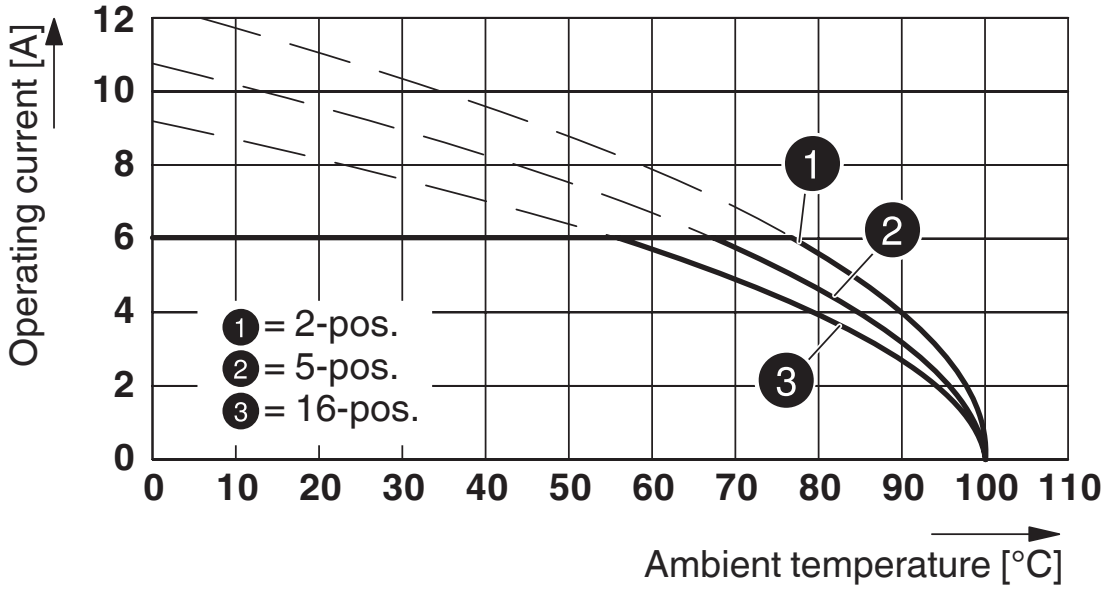
| | |
|---|---|
| Dimensional drawing |  |
| Type of packaging | 56 mm wide tape |
| [W] tape width | 56 mm |
| [W2] coil overall dimension | ≤ 62.4 mm |
| [A] coil diameter | ≤ 330 mm |
| Outer packaging type | Transparent-Bag |

## Drawings

Dimensional drawing

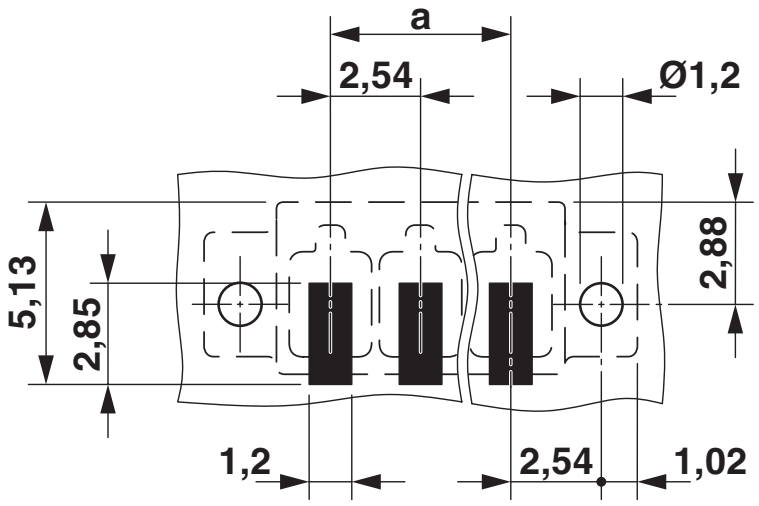



Diagram




Type FMC 0,5/...-ST-2,54 with MCV 0,5/...-G-2,54 SMD R..

Drilling plan/solder pad geometry



## Approvals

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1821627

**cULus Recognized**
Approval ID: E60425-19920306

| | Nominal voltage $U_N$ | Nominal current $I_N$ | Cross section AWG | Cross section $mm^2$ |
|---|---|---|---|---|
| B | | | | |
| Field wiring | 150 V | 6 A | - | - |
| C | | | | |
| Factory wiring | 50 V | 6 A | - | - |

**VDE report with production monitoring**
Approval ID: 40042258

| | Nominal voltage $U_N$ | Nominal current $I_N$ | Cross section AWG | Cross section $mm^2$ |
|---|---|---|---|---|
| keine | | | | |
| | 160 V | 6 A | - | - |

## Classifications

### ECLASS

| | |
|---|---|
| ECLASS-13.0 | 27460201 |
| ECLASS-15.0 | 27460201 |

### ETIM

| | |
|---|---|
| ETIM 10.0 | EC002637 |

### UNSPSC

| | |
|---|---|
| UNSPSC 21.0 | 39121400 |

## Environmental product compliance

EU RoHS

| | |
|---|---|
| Fulfills EU RoHS substance requirements | Yes, No exemptions |

China RoHS

| | |
|---|---|
| Environment friendly use period (EFUP) | EFUP-E |
| | No hazardous substances above the limits |

EU REACH SVHC

| | |
|---|---|
| REACH candidate substance (CAS No.) | No substance above 0.1 wt% |

EF3.1 Climate Change

| | |
|---|---|
| CO2e kg | 0.191 kg CO2e |


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